

### **US2AW THRU US2MW**

### SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER

Reverse Voltage - 50 to 1000 V Forward Current - 2 A

#### **FEATURES**

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- High efficiency
- Lead free in comply with EU RoHS 2011/65/EU directives

#### **MECHANICAL DATA**

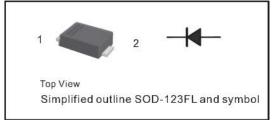
• Case: SOD-123FL

• Terminals: Solderable per MIL-STD-750, Method 2026

• Approx. Weight:15mg 0.00053oz

### **Maximum Ratings and Electrical characteristics**

PIN	DESCRIPTION
1	Cathode
2	Anode



Ratings at  $25^{\circ}$ C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	US2AW	U\$2BW	U\$2DW	US2GW	US2JW	U\$2KW	US2MW	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	Vpc	50	100	200	400	600	800	1000	٧
Maximum Average Forward Rectified Current at Ta = 65 °C	I <sub>F(AV)</sub>	2							Α
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	lesm	50						Α	
Maximum Instantaneous Forward Voltage at 2 A	V <sub>F</sub>	1.0 1.4 1.68					٧		
Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta = 125 °C	I <sub>R</sub>	5 100						μA	
Maximum Reverse Recovery Time 1>	t,,,	50 75						ทธ	
Typical Junction Capacitance 2>	C <sub>j</sub>	25							рF
Typical Thermal Resistance 3>	R <sub>g,IA</sub>	90							°C/W
Operating and Storage Temperature Range	Tj, Tsig	-55~+150							°C

- 1 ) Measured with  $I_F\!=\!0.5$  A,  $I_R\!=\!1$  A,  $I_{rr}\!=\!0.25$  A
- 2 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C
- 3 ) P.C.B. mounted with 0.2x0.2" ( 5.0x5.0 mm ) copper pad areas.

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Fig.1 Maximum Average Forward Current Rating

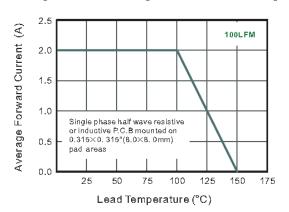


Fig.3 Typical Forward Characteristics

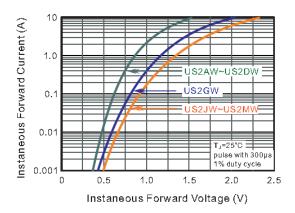


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

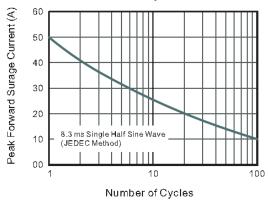


Fig.2 Typical Reverse Characteristics

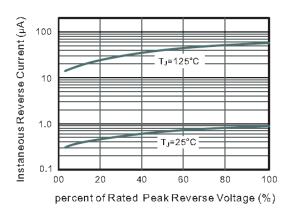


Fig.4 Typical Junction Capacitance

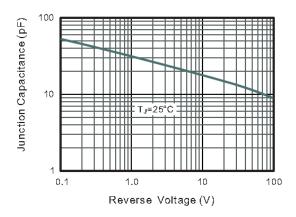
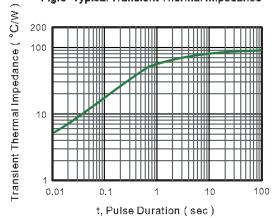


Fig.6- Typical Transient Thermal Impedance

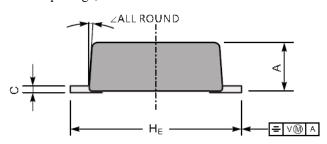




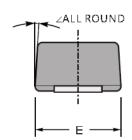
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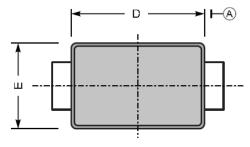
### PACKAGE OUTLINE

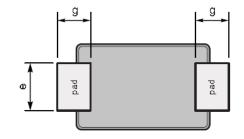
Plastic surface mounted package; 2 leads









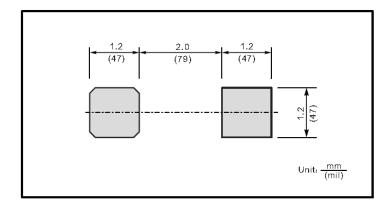


Top View

Bottom View

UNIT		Α	С	D	Е	е	g	HE	
mm	max	1.1	0.20	2.9	1.9	1.1	0.9	3.8	
	min	0.9	0.12	2.6	1.7	8.0	0.7	3.5	7°
mil	max	43	7.9	114	75	43	35	150	,
	min	35	4.7	102	67	31	28	138	

### The recommended mounting pad size



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### 单击下面可查看定价,库存,交付和生命周期等信息

>>SHIKUES(时科)